

**IN THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application.

1-18 (Canceled)

19. (Currently amended) A method of manufacturing a display device, comprising:

~~a first step of forming at least one concave portion in a front surface of a second substrate;~~

~~a second step of bonding a first substrate and the second substrate; and~~

~~a third step of applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.~~

20. (Currently amended) A method of manufacturing a display device according to claim 19 further comprising: ~~a step of forming a scribe line in a front surface of the first substrate before the second step, and~~

~~wherein the second step includes a step of making cracks develop in the first substrate from the scribe line by impacting a cutaway portion of the second substrate with the first substrate, and cutting the first substrate.~~

21. (Currently amended) A method of manufacturing a display device according to claim 19 further comprising: ~~a step of forming a scribe line in a rear surface of the first substrate before~~

~~the second step, and~~

~~wherein the second step includes a step of making cracks develop in the first substrate from the scribe line by impacting a cutaway portion of the second substrate with the first substrate, and cutting the first substrate.~~

22. (Original) A method of manufacturing a display device according to claim 19, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate

23. (Original) A method of manufacturing a display device, comprising a step of bonding a first substrate and a second substrate in which at least one concave portion is formed through a seal pattern,

wherein a step of hardening the seal pattern is performed in a arrangement in which the first substrate is at an upper side and the second substrate is at a lower side.

24. (New) A method of manufacturing a display device according to claim 23, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate

25. (New) A method of manufacturing a display device, comprising:

- preparing a second substrate having at least one concave portion;
- bonding a first substrate and the second substrate; and
- applying pressure to a rear surface of the second substrate, making cracks develop

in the second substrate from the concave portion, and cutting the second substrate.

26. (New) A method of manufacturing a display device according to claim 25 further comprising:

forming a scribe line in a front surface of the first substrate, and

making cracks develop in the first substrate from the scribe line by impacting a cutaway portion of the second substrate with the first substrate, and cutting the first substrate.

27. (New) A method of manufacturing a display device according to claim 25 further comprising:

forming a scribe line in a rear surface of the first substrate, and

making cracks develop in the first substrate from the scribe line by impacting a cutaway portion of the second substrate with the first substrate, and cutting the first substrate.

28. (New) A method of manufacturing a display device according to claim 25, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate.

29. (New) A method of manufacturing a display device, comprising:

forming at least one concave portion in a front surface of a second substrate; and

bonding a first substrate and the second substrate through a sealing material;

wherein the sealing material fills the concave portion of the second substrate.

30. (New) A method of manufacturing a display device according to claim 29 further comprising:

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

31. (New) A method of manufacturing a display device according to claim 29, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate

32. (New) A method of manufacturing a display device, comprising:

preparing a second substrate having at least one concave portion; and  
bonding a first substrate and the second substrate through a sealing material;  
wherein the sealing material fills the concave portion of the second substrate.

33. (New) A method of manufacturing a display device according to claim 32 further comprising:

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

34. (New) A method of manufacturing a display device according to claim 32, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate

35. (New) A method of manufacturing a display device, comprising:

forming a scribe line in a rear surface of the first substrate;  
forming at least one concave portion in a front surface of a second substrate; and  
bonding the first substrate and the second substrate through a sealing material;  
wherein the sealing material fills the concave portion of the second substrate.

36. (New) A method of manufacturing a display device according to claim 35 further comprising:

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

37. (New) A method of manufacturing a display device according to claim 35, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate

38. (New) A method of manufacturing a display device, comprising:

preparing a first substrate having a scribe line and a second substrate having at least one concave portion; and  
bonding the first substrate and the second substrate through a sealing material;  
and  
wherein the sealing material fills the concave portion of the second substrate.

39. (New) A method of manufacturing a display device according to claim 38 further comprising:

applying pressure to a rear surface of the second substrate, making cracks develop in the second substrate from the concave portion, and cutting the second substrate.

40. (New) A method of manufacturing a display device according to claim 38, wherein a light emitting element, in which an anode, an organic layer, and a cathode are laminated, is formed on the first substrate